

MBL Series Evaluation Kit User Manual

New Generation Package Compatible Sub-1G Wireless Module ${\tt E32-400MBL-01}$





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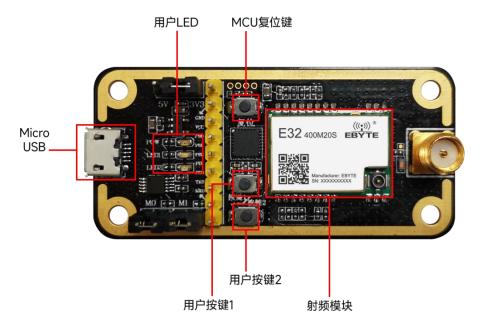
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I Product Introduction



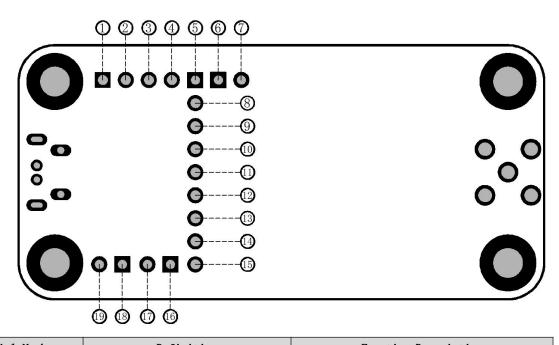
1.1 Product Description

The MBL series evaluation kits are designed to help users quickly evaluate the new generation of package-compatible wireless modules from EBST. Most of the pins on the board are already pinned out to both sides of the row of pins, so developers can easily connect a variety of peripheral devices through jumpers according to their actual needs.

The kit provides complete software application examples to help customers quickly get started with wireless data communication development. Different types of Sub-1G wireless modules can be on-board according to customer requirements. The supported modules are available in pin-compatible packages and can be quickly replaced.

1.2 Size, interface description





Pin Serial Number	Definition	Function Description	
1	VCC	Module power supply pin, need to short with	
		pin 2 to power the module	
2	3.3V	3.3V electrical lead pin	
3	3.3V	3.3V electrical lead pin	
4	VIO	MCU power supply pin, need to short with pin	
		3 to power MCU	
5	GND	Base plate reference ground	
6	REST	MCU external reset pins	
7	SWIM	SWIM pins of MCU	
8	VIO	MCU power supply pins	
9	PC0	Module reset pins	
10	PB7	Module MISO Pinout	
11	PB6	Module MOSI Pinout	
12	PB5	Module SCLK pins	
13	PB4	Module NSS Pinout	
14	TXD	MCU serial port TXD	
15	RXD	MCU serial port RXD	
16	M1	Module mode switching pins (see module	
		product manual for details)	
17	GND	Base plate reference ground	
18	MO	Module mode switching pins (see module	
		product manual for details)	
19	GND	Base plate reference ground	

1.3 Support List



	RF Chips	Manufacturer	Module Model
1	CC1101	Texas Instruments	E07-400M10S
2	CC1101	101 Texas Instruments E07-900M10S	
3	SI4438	Silicon Labs	E30-400M20S
4	SI4463	Silicon Labs	E30-900M20S
5	LLCC68	CC68 Semtech E220-400M22S	
6	LLCC68	Semtech	E220-900M22S
7	SX1278	Semtech	E32-400M20S
8	SX1276	Semtech	E32-900M20S
9	SX1268	Semtech	E22-400M22S
10	SX1262	Semtech	E22-900M22S
11	AX5243	ON Semiconductor	E31-400M17S
12	LLCC68	Semtech	E220-400MM22S
13	LLCC68	Semtech	E220-900MM22S



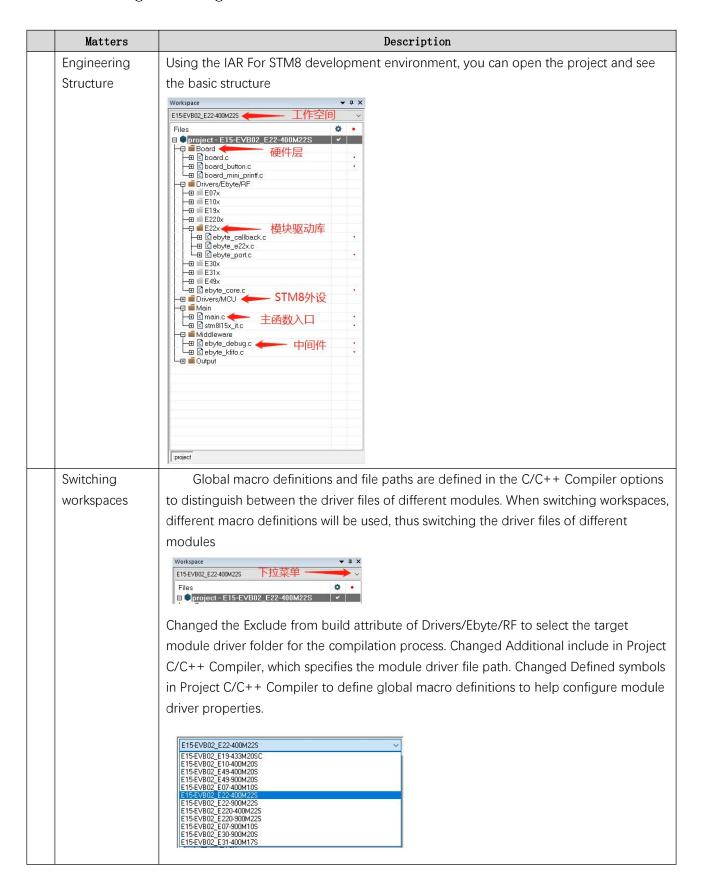
II Software Introduction

2.1 Catalogue structure

	Matters	Description		
1	File Directory	You can download the sample project from the official website and open the directory as shown below O_Project I_Middleware Z_Ebyte_Board_Support J_3_Ebyte_WirelessModule_Drivers 4_STM8_L15x_StdPeriph_Drivers		
2	Catalog Description	You can use the IAR For STM8 development environment to find the entry file and open the project E15-EVB02 Demo		
		☐ 4_STM8_L15x_StdPeriph_Drivers		



2.2 IAR Engineering



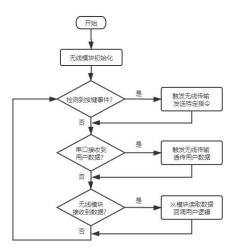


2.3 Main function

main.c in which is the main function entry. The flow of the demonstration function is simplified as follows:

	Matters	Description	
1	Key Function	If a key is pressed, the command data is sent wirelessly. In essence, this means	
		sending a specific string "ping" and expecting to receive a response "pong".	
2	Serial data to wireless	The serial port automatically starts transmitting data wirelessly when it receives	
	transmission	the data, which of course contains some special command responses that are	
		mainly used for special tests and can be ignored by the user. Once the	
		transmission is complete, the user function is automatically called back so that the	
		transmission logic can be handled by itself.	
3	Receive data	The underlying driver will copy the data and pass it to the user callback function,	
	wirelessly	which will handle the receiving logic itself.	

The software process is simplified as shown in the following diagram:



2.4 Sending and Receiving Timing

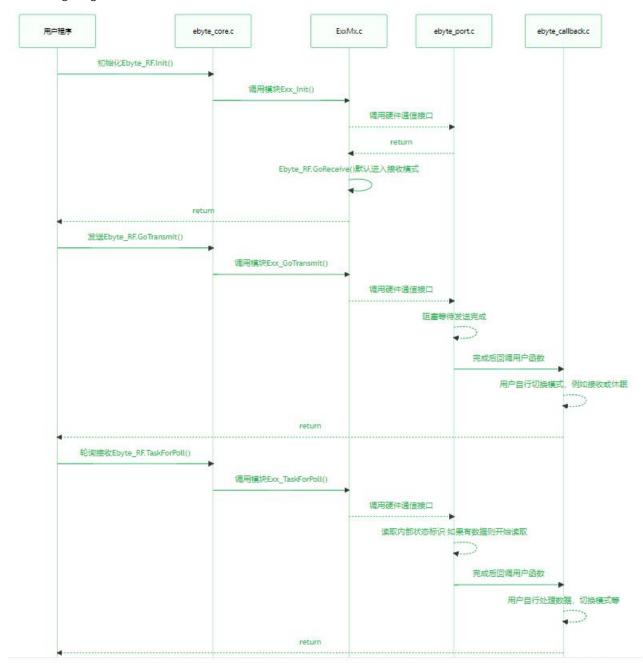
Wireless modules exist in multiple operating states and can only perform specific functions in the corresponding states. In terms of the simplest sending and receiving data, only the transmitting mode and receiving mode are considered.

	Matters	Description	
1	Receiving Mode	Receive mode is automatically entered after the default initialization is completed.	
		In essence, this means that the receive function is called during initialization and	
		thus enters receive mode. If you want to consider entering other modes after	
		initialization, such as sleep, you can directly replace the function Go_xxxxx() with	
		the same type.	
2	Sending Mode	When the transmit function is called, the underlying driver actually switches the	
		module into standby mode first, where the configuration of modulation	
		parameters, such as frequency, power, frequency bias, etc., is usually done. After	
		the parameters are configured correctly, it gradually enters some intermediate	
		modes, turning on the internal FIFO, PA, external XTAL, etc., and the current	



consumption gradually climbs. Finally switch into transmit mode to trigger wireless data transmission. After completion, the module enters standby mode, this state can not continue to send and receive, and the user needs to handle the next mode in the callback function by himself. When the function is complicated and continuous receiving or continuous transmitting is needed, please further switch other modes according to the chip characteristics.

The timing diagram is shown below.





2.5 Programming

	Documents	Key Notes
1	ebyte_core.h	A module structure is defined that abstracts the basic functionality to which the functions of the underlying module will be bound. When used for simple sending and receiving applications, it is not necessary to understand the underlying details of each module's work, and the abstracted functions can be called directly to start sending and receiving data. If you need to customize some functions, you can also consider integrating them into this structure. If you know enough about the functions of the underlying modules, you can also remove the ebyte_core.c/h file, and there is no strong coupling between the typedef struct { uint8e t (*Init)(void); ////////////////////////////////////
2	ebyte_exx.c	It is a specific module driver file, which is generally encapsulated and does not require user changes, only how to input and output data from this "box".
3	ebyte_port.c	Specifically designed to bind SPI and GPIO on different hardware platforms,
		abstracted as "box" inputs. Users need to populate their hardware platforms with communication interfaces in fixed locations according to the comments. In general, it is to provide the SPI send/receive function and the pin level control. Some modules are slightly special, such as the E49 using half-duplex SPI, if you are too lazy to write the communication driver, then directly bind the IO to a fixed location, and leave the rest to the module driver to simulate their own IO to achieve communication. As shown in the figure below, in the comments required to provide the SPI interface location to fill in the specific send and receive functions, from send to pass the SPI send data, by the result to return the SPI receive Apparam send EVYI Spill December D
	ebyte_callback.c	It is specifically designed to bind the user's own sending and receiving logic,
		abstracted as the output of a "box". Essentially, the module driver calls the user's
		callback function directly after determining whether sending or receiving is complete.



As shown below, the user's logic is populated in the To-do prompt location. state is passed from the module driver and actually handled by the Exx_GoTransmit() function, which can be modified to support more cases when the functionality is complex. *@brief发送完成回调接口由客户实现自己的发送完成逻辑 *@param state 上层回调提供的状态码 客户请根据示例注释找到对应区域 void Ebyte_Port_TransmitCallback(uint16e_t state) /*发送:正常完成*/ if(state &= 0x0001) //To-do 实现自己的逻辑 UserTransmitDoneCallback(); /*发送:其他情况*/ //To-do 实现自己的逻辑 ebyte_exx.h Some general modulation parameters are defined, which usually do not need to be modified and can be adjusted by yourself in them. Note, please understand the comments when modifying, there is a range check for the parameters in the module driver, wrong modulation parameters will lead to initialization failure. The following is an example of FSK modulation #define E07 DATA RATE #define E07 FREQUENCY DEVIATION 14300 #define E07 BANDWIDTH #define E07 PREAMBLE SIZE #define E07 SYNC WORD parameters. board.c STM8 peripheral initialization, involving SPI, TIMER, GPIO, etc., strongly coupled to the hardware used. board_button.c The keystroke event queue, in terms of data structure, is a FIFO, and the timer detects the keystroke and stores the corresponding event in the queue waiting for the main loop to respond. board_mini_printf.c A simplified printf, with reduced functionality but a small footprint. The DEBUG macro in the project relies heavily on the mprintf provided by this file. ebyte kfifo.c For serial data reception, optimized for general-purpose FIFO queues, suitable for ebyte_debug.c Used to connect to a PC for some tests, generally not required. stm8l15x_it.c

All interrupt functions are entered here, and the interrupt service functions for serial,

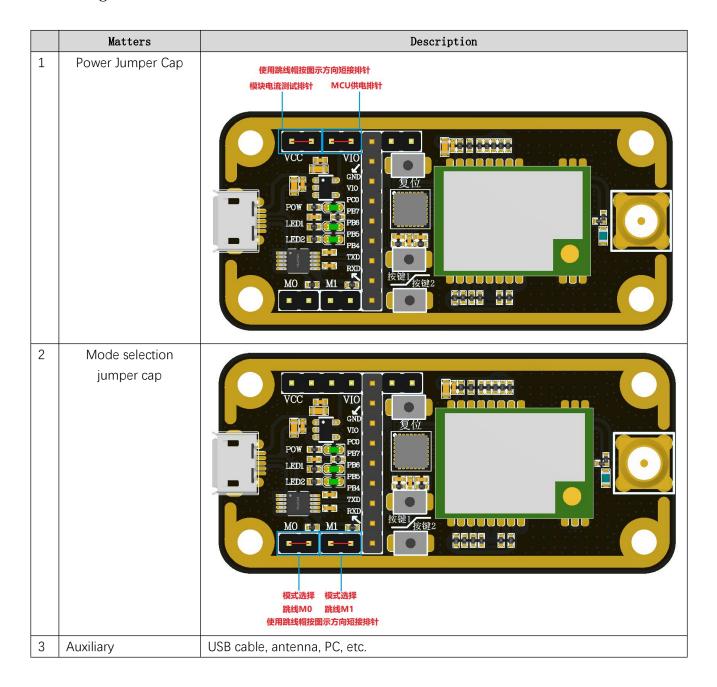


	timer, key IO, etc. are concentrated here.



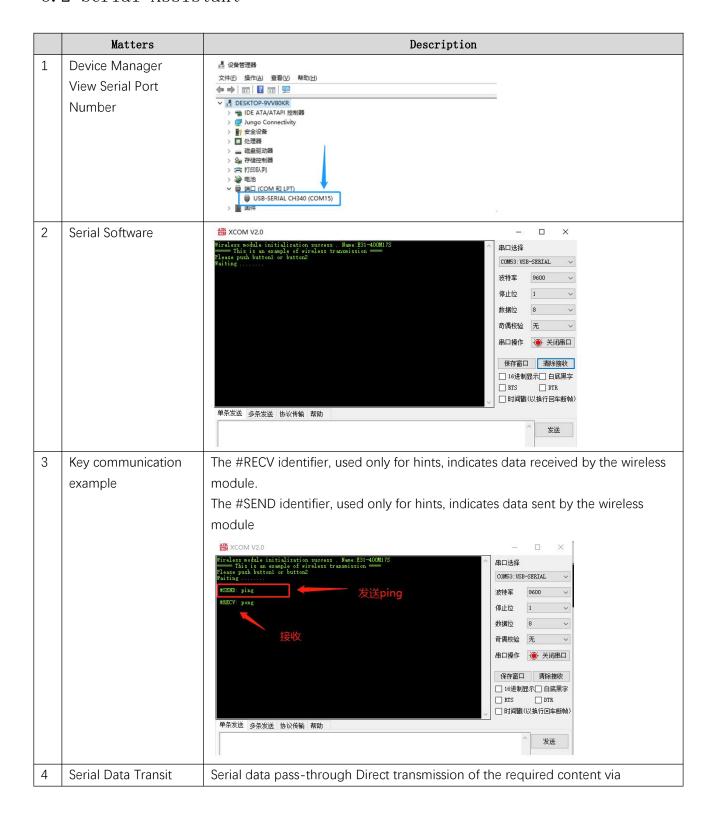
III Quick Demo

3.1 Signal cable connection





3.2 Serial Assistant







IV Frequently Asked Questions

4.1 Unsatisfactory transmission distance

- A corresponding attenuation of communication distance when linear communication barriers exist.
- Temperature, humidity, and co-channel interference, which can lead to higher communication packet loss rates.
- The ground absorbs and reflects radio waves, and the test effect is poor near the ground.
- seawater has a very strong ability to absorb radio waves, so the seaside test effect is poor.
- metal objects near the antenna, or placed in a metal shell, signal attenuation will be very serious.
- Wrong setting of power register, too high setting of air rate (the higher the air rate, the closer the distance).
- the low voltage of the power supply at room temperature is lower than the recommended value, the lower the voltage the less power is generated
- The use of antenna and module match the degree of poor or antenna itself quality problems.

4.2 Module is vulnerable to damage

- Please check the power supply to ensure that it is between the recommended supply voltages, as exceeding the maximum will cause permanent damage to the module.
- Please check the stability of the power supply, the voltage should not fluctuate significantly and frequently.
- Please ensure that the installation and use process anti-static operation, high-frequency devices electrostatic sensitivity.
- Please ensure that the installation and use process humidity should not be too high, some components are humidity-sensitive devices.
- If there is no special demand is not recommended to use at too high or too low temperature.

4.3 BER is too high

- Nearby interference with the same frequency signal, away from the source of interference or modify the frequency, channel to avoid interference.
- unsatisfactory power supply may also cause garbled codes, be sure to ensure the reliability of the power supply.
- Poor quality or too long extension cable or feeder line may also cause high BER.



Revision History

Versions	Revision Date	Revision Notes	Maintainers
1.0	2021-09-22	Initial Version	ЈН
1.1	2022-12-29	Modify the module diagram and how to use	HWJ

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